506461571 01/21/2021

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6508347

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
LALAN JEE MISHRA	12/16/2020
NAVEEN KUMAR NARALA	01/14/2021
RICHARD DOMINIC WIETFELDT	12/14/2020
CHRISTOPHER KONG YEE CHUN	01/08/2021

RECEIVING PARTY DATA

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17037984

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 919-238-2300
Email: dsmith@wt-ip.com
Correspondent Name: W&T/QUALCOMM

Address Line 1: 106 PINEDALE SPRINGS WAY
Address Line 4: CARY, NORTH CAROLINA 27511

ATTORNEY DOCKET NUMBER:	203139/1173-675
NAME OF SUBMITTER:	DAVID M. SMITH
SIGNATURE:	/David M. Smith/
DATE SIGNED:	01/21/2021

Total Attachments: 6

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PATENT 506461571 REEL: 054988 FRAME: 0537

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ASSIGNMENT

WHEREAS, WE,

- 1. Lalan Jee MISHRA, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714,
- 2. Naveen Kumar NARALA, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714,
- 3. Richard Dominic WIETFELDT, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714,
- 4. Christopher Kong Yee CHUN, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **EXPANDED FUNCTION DATAGRAM IN A SYSTEM POWER MANAGEMENT INTERFACE (SPMI) SYSTEM** (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, **QUALCOMM Incorporated** (hereinafter "**ASSIGNEE**"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 17/037,984 filed September 30, 2020, Qualcomm Reference Number 203139, and all provisional applications relating thereto, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

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AND WE HEREBY coverant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	san Diege Gostale	om <u>12/6/20</u>	Latin Jee MISHIKA
Done at	City, State	on	Naveen Kumar NARALA
Done at	City, Sinte	on Date	Richard Dominic WIETFELDT
Done at	, City, State	on	Christopher Kong Yee CHUN

PATENT Qualcomm Reference Number 203139 Page 3 of 3

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Jone at	Date	Lalan Joe MISHRA
Done st Benjalun		
City, State	Date	Naveen Kumar NARALA
Done atCity, State	, on Date	Richard Dominic WIETFELDT
Done at	, on	Christopher Kong Yee CHUN

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _		on	
	City, State	Date	Lalan Jee MISHRA
Done at _		on	
	City, State	Date	Naveen Kumar NARALA
Done at _	5-0-10 CA,	on_12/14/2020	Lichar Down anthod
	City, State	Date	Richard Dominic WIETFELDT
Done at _	9	on	
	City, State	Date	Christopher Kong Yee CHUN

PATENT Qualcomm Reference Number: 203139 Page 3 of 3

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at		on	
	City, State		Lalan Jee MISHRA
Done at		on	
	City, State	Date	Naveen Kumar NARALA
Dama at		20	
Done at	City, State	On	Richard Dominic WIETFELDT
Done at	Austin, TX.	on & January 2021	Classification Christopher Kong Yee CHUN
	City, State	Date	Christopher Kong Yee CHUN

PATENT REEL: 054988 FRAME: 0544

RECORDED: 01/21/2021